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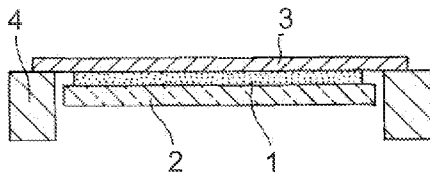
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(54) Title: METHOD FOR DETACHING PRESSURE-SENSITIVE ADHESIVE FILM



(57) Abstract: To provide a detaching method capable of detaching a first substrate and a second substrate bonded together through a pressure-sensitive adhesive film, while minimizing the physical external load imposed on these substrates. A method for detaching a first substrate and a second substrate bonded together by a pressure-sensitive adhesive film comprising a pressure-sensitive adhesive polymer having dispersed therein a thermally decomposable metal hydroxide or metal salt hydrate filler, the method comprising a step of heating the pressure-sensitive adhesive film to a temperature capable of causing decomposition and dehydration of the metal hydroxide or metal salt hydrate, thereby accelerating the detachment.

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